	MW 1.2 03-06-200	00	
PA	TO THE CON	Attorney Docket No. 9651/4012	
	10128202(Dit or copy thereof.	
1.	Name of Party(ies) conveying an interest: Makoto Sasaki Kenji Yamamoto	Name and Address of Party(ies) receiving and interest: Name: EPONTEC INCORPORATED	
Ad	ditional name(s) of conveying party(ies) attached? ☐ Yes ☒ No	Internal Address: 3-31 Ake-dori, Izum-ku	
		Additional name(s) and addresses attached? ☐ Yes ☒ No	
3.	Description of the interest conveyed: Assignment Change of Name	Other: Corrected Assignment Cover Sheet to correct Assignee recorded on reel 10211 and frame 723	
 	Execution Date: Application number(s) or patent number(s). Additional sheet attached? Yes No		
	If this document is being filed together with a new application, the execution date of the application is:		
Date			
09/	Patent Application No.(s) /385,184	Patent No.(s)	
}			
5.	Additional numbers attaction Name and address of party to whom correspondence	ned?	
٥.	concerning document should be mailed:	o. Number of applications and patents involved. One	
	BRINKS HOFER GILSON & LIONE P.O. BOX 10395 CHICAGO, IL. 60610	Total fee (37 CFR 3.41) \$40.00 ☐ Enclosed ☐ Authorized to be charged to Deposit Account	
	(312)321-4200	No. 23-1925 8. Please charge any deficiencies in fee or credit any overpayment to Deposit Account No. 23-1925.	
03/03/2	000 DCDATES 00000086 09385184 DO NOT USE TH	HIS SPACE	
01 FC:5	81 (40.00 OP)		
	Statement and signature. the best of my knowledge and belief, the foregoing informatory of the original document.	ion is true and correct and any attached copy is a true	
Į.	Custova Sillar, Ir	1/18/00	
	Gustavo Siller, Jr. Name of Person Signing Signing	gnature Date	

Total number of pages including cover sheet, attachments, and document: Three (3)

Rev. Oct-97

PATENT REEL: 010578 FRAME: 0696

ASSIGNMENT

WHEREAS, Makoto Sasaki and Kenji Yamamoto

hereinafter called the "Assignors", have made the invention described in the United States patent application entitled Constituent Substrate for Electronic Equipment Using Wiring Layer Made of Copper and Transparent Conductive Layer Made of Composite Oxide Containing Indium Oxide and Metal Oxide as Main Components and Electronic Equipment Using the Same

executed by Assignors on the same date as this Assignment;

WHEREAS, FRONTEC INCORPORATED, a corporation organized and existing under the laws of Japan, having a place of business at 3-31 Ake-dori, Izumi-ku, Sendai-shi, Miyagi-ken, Japan, hereinafter called the "Assignee", desires to acquire the entire right, title and interest in and to the invention and the patent application identified above, and all patents which may be obtained for said invention, as set forth below;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$100), and other valuable and legally sufficient consideration, the receipt of which by the Assignors from the Assignee is hereby acknowledged, the Assignors have sold, assigned and transferred, and by these presents do sell, assign and transfer to the Assignee, the entire right, title and interest for the United States in and to the invention and the patent application identified above, and any patents that may issue for said invention in the United States; together with the entire right, title and interest in and to said invention and all patent applications and patents therefor in all countries foreign to the United States, including the full right to claim for any such application all benefits and priority rights under any applicable convention; together with the entire right, title and interest in and to all continuations, divisions, renewals and extensions of any of the patent applications and patents defined above; to have and to hold for the sole and exclusive use and benefit of the Assignee, its successors and assigns, to the full end of the term or terms for all such patents.

The Assignors hereby covenant and agree, for both the Assignors and the Assignors' legal representatives, that the Assignors will assist the Assignee in the prosecution of the patent application identified above; in the making and prosecution of any other patent applications that the Assignee may elect to make covering the invention identified above; in vesting in the Assignee like exclusive title in and to all such other patent applications and patents; and in the prosecution of any interference which may arise involving said invention, or any such patent application or patent; and that the Assignors will execute and deliver to the Assignee any and all additional papers which may be requested by the Assignee to carry out the terms of this Assignment.

PATENT REEL: 010578 FRAME: 0697 The Commissioner of Patents and Trademarks is hereby authorized and requested to issue patents to the Assignee in accordance with the terms of this Assignment. IN TESTIMONY WHEREOF, the Assignors have executed this agreement.

DATE: <u>July 27, 1999</u>	Makoto Sasaki
	Inventor: Makoto Sasaki
WITNESSED:	
DATE: <u>July 27, 1999</u>	Hileo Kurokawa
DATE: July 27, 1999	Kazumi Yazawa
DATE: <u>July 27, 1999</u>	Henry Garante
WITNESSED:	Inventor: Kenji Yamamoto
DATE: <u>July 27, 1999</u>	Kideo Kurokawa
DATE: <u>July 27, 1999</u>	Kazumi Yazawa
DATE:	
WITNESSED:	Inventor:
DATE:	
DATE:	
DATE:	T
WITNESSED:	Inventor:
DATE:	
DATE:	

PATENT REEL: 010578 FRAME: 0698